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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
	Active
Product Status	
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-VQFN Exposed Pad
Supplier Device Package	16-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1823-i-ml

TABLE 3-5: PIC12(L)F1822/16(L)F1823 MEMORY MAP, BANKS 16-23

	BANK 16	`	BANK 17	•	BANK 18		BANK 19		BANK 20		BANK 21		BANK 22		BANK 23
800h	INDF0	880h	INDF0	900h	INDF0	980h	INDF0	A00h	INDF0	A80h	INDF0	B00h	INDF0	B80h	INDF0
801h	INDF1	881h	INDF1	901h	INDF1	981h	INDF1	A01h	INDF1	A81h	INDF1	B01h	INDF1	B81h	INDF1
802h	PCL	882h	PCL	902h	PCL	982h	PCL	A02h	PCL	A82h	PCL	B02h	PCL	B82h	PCL
803h	STATUS	883h	STATUS	903h	STATUS	983h	STATUS	A03h	STATUS	A83h	STATUS	B03h	STATUS	B83h	STATUS
804h	FSR0L	884h	FSR0L	904h	FSR0L	984h	FSR0L	A04h	FSR0L	A84h	FSR0L	B04h	FSR0L	B84h	FSR0L
805h	FSR0H	885h	FSR0H	905h	FSR0H	985h	FSR0H	A05h	FSR0H	A85h	FSR0H	B05h	FSR0H	B85h	FSR0H
806h	FSR1L	886h	FSR1L	906h	FSR1L	986h	FSR1L	A06h	FSR1L	A86h	FSR1L	B06h	FSR1L	B86h	FSR1L
807h	FSR1H	887h	FSR1H	907h	FSR1H	987h	FSR1H	A07h	FSR1H	A87h	FSR1H	B07h	FSR1H	B87h	FSR1H
808h	BSR	888h	BSR	908h	BSR	988h	BSR	A08h	BSR	A88h	BSR	B08h	BSR	B88h	BSR
809h	WREG	889h	WREG	909h	WREG	989h	WREG	A09h	WREG	A89h	WREG	B09h	WREG	B89h	WREG
80Ah	PCLATH	88Ah	PCLATH	90Ah	PCLATH	98Ah	PCLATH	A0Ah	PCLATH	A8Ah	PCLATH	B0Ah	PCLATH	B8Ah	PCLATH
80Bh	INTCON	88Bh	INTCON	90Bh	INTCON	98Bh	INTCON	A0Bh	INTCON	A8Bh	INTCON	B0Bh	INTCON	B8Bh	INTCON
80Ch	_	88Ch	_	90Ch	_	98Ch	_	A0Ch		A8Ch		B0Ch	_	B8Ch	_
80Dh	_	88Dh	_	90Dh	_	98Dh	_	A0Dh		A8Dh		B0Dh	_	B8Dh	_
80Eh	_	88Eh	_	90Eh	_	98Eh	_	A0Eh		A8Eh		B0Eh	_	B8Eh	_
80Fh	_	88Fh	_	90Fh	_	98Fh	_	A0Fh		A8Fh	1	B0Fh	_	B8Fh	_
810h	_	890h	_	910h	_	990h	_	A10h	1	A90h		B10h	_	B90h	_
811h	_	891h	_	911h	_	991h	_	A11h	_	A91h	_	B11h	_	B91h	_
812h	_	892h	_	912h	_	992h	_	A12h		A92h		B12h	_	B92h	_
813h	_	893h	_	913h	_	993h	_	A13h		A93h		B13h	_	B93h	_
814h	_	894h	_	914h	_	994h	_	A14h	I	A94h		B14h		B94h	_
815h	_	895h	_	915h	_	995h	_	A15h		A95h	_	B15h	_	B95h	_
816h	_	896h	_	916h	_	996h	_	A16h		A96h		B16h	_	B96h	_
817h	_	897h	_	917h		997h	_	A17h		A97h		B17h		B97h	_
818h	_	898h	_	918h	_	998h	_	A18h	1	A98h		B18h	_	B98h	_
819h	_	899h	_	919h	_	999h	_	A19h		A99h		B19h	_	B99h	_
81Ah	_	89Ah	_	91Ah	_	99Ah	_	A1Ah	_	A9Ah	_	B1Ah	_	B9Ah	_
81Bh	_	89Bh	_	91Bh	_	99Bh	_	A1Bh		A9Bh	1	B1Bh	_	B9Bh	_
81Ch	_	89Ch	_	91Ch	_	99Ch	_	A1Ch	1	A9Ch		B1Ch	_	B9Ch	_
81Dh	_	89Dh	_	91Dh	_	99Dh	_	A1Dh		A9Dh	_	B1Dh	_	B9Dh	_
81Eh	_	89Eh	_	91Eh	_	99Eh	_	A1Eh		A9Eh	_	B1Eh	_	B9Eh	_
81Fh	_	89Fh	_	91Fh	_	99Fh	_	A1Fh	_	A9Fh	_	B1Fh	_	B9Fh	_
820h		8A0h		920h		9A0h		A20h		AA0h		B20h		BA0h	
	Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'
86Fh		8EFh		96Fh		9EFh		A6Fh		AEFh		B6Fh		BEFh	
870h		8F0h		970h		9F0h		A70h		AF0h		B70h		BF0h	
0.011	Accesses	3. 011	Accesses	3.011	Accesses	3. 011	Accesses	011	Accesses	011	Accesses	2.011	Accesses	2. 011	Accesses
	70h – 7Fh		70h – 7Fh		70h – 7Fh		70h – 7Fh		70h – 7Fh		70h – 7Fh		70h – 7Fh		70h – 7Fh
87Fh		8FFh		97Fh		9FFh		A7Fh		AFFh		B7Fh		BFFh	
L		,				1		ļi		•				,	I

Legend: = Unimplemented data memory locations, read as '0'.

TABLE 3-8: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

IABLE	3 - 0. 3	FECIAL F	ONC HON	KEGIST	EK SUMIN	IAK I (CC	ם טאוו ו אוכ	(ט:			
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 1											
080h ⁽¹⁾	INDF0	Addressing the (not a physical		es contents of	FSR0H/FSR0	L to address	data memory	1		xxxx xxxx	xxxx xxxx
081h ⁽¹⁾	INDF1	Addressing the (not a physical		es contents of	FSR1H/FSR1	L to address	data memory	1		xxxx xxxx	xxxx xxxx
082h ⁽¹⁾	PCL	Program Cou	Program Counter (PC) Least Significant Byte								
083h ⁽¹⁾	STATUS	_	_	_	TO	PD	Z	DC	С	1 1000	q quuu
084h ⁽¹⁾	FSR0L	Indirect Data	Memory Addr	ess 0 Low Poir	nter					0000 0000	uuuu uuuu
085h ⁽¹⁾	FSR0H	Indirect Data	Memory Addr	ess 0 High Poi	nter					0000 0000	0000 0000
086h ⁽¹⁾	FSR1L	Indirect Data	Memory Addr	ess 1 Low Poir	nter					0000 0000	uuuu uuuu
087h ⁽¹⁾	FSR1H	Indirect Data	Memory Addr	ess 1 High Poi	nter					0000 0000	0000 0000
088h ⁽¹⁾	BSR	_	_	_			BSR<4:0>			0 0000	0 0000
089h ⁽¹⁾	WREG	Working Reg	ister							0000 0000	uuuu uuuu
08Ah ⁽¹⁾	PCLATH	_	Write Buffer f	or the upper 7	bits of the Pro	gram Counte	r			-000 0000	-000 0000
08Bh ⁽¹⁾	INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	0000 000x	0000 000u
08Ch	TRISA	_	_	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	11 1111	11 1111
08Dh	_	Unimplement	ted		·	I.		·	I.	_	_
08Eh	TRISC ⁽²⁾	_	_	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	11 1111	11 1111
08Fh		Unimplement	ted	•						_	_
090h		Unimplement	ted							_	_
091h	PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
092h	PIE2	OSFIE	C2IE ⁽²⁾	C1IE	EEIE	BCL1IE	_	_	_	0000 0	0000 0
093h	_	Unimplement	ted	•	•	•		•	•	_	_
094h	_	Unimplement	ted							_	_
095h	OPTION_REG	WPUEN	INTEDG	TMR0CS	TMR0SE	PSA		PS<2:0>		1111 1111	1111 1111
096h	PCON	STKOVF	STKUNF	_	_	RMCLR	RI	POR	BOR	00 11qq	qq qquu
097h	WDTCON	_	_		V	/DTPS<4:0>			SWDTEN	01 0110	01 0110
098h	OSCTUNE	_	_			TUN<	5:0>			00 0000	00 0000
099h	OSCCON	SPLLEN		IRCF	<3:0>		_	SCS	S<1:0>	0011 1-00	0011 1-00
09Ah	OSCSTAT	T10SCR	PLLR	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS	10q0 0q00	qqqq qq0q
09Bh	ADRESL	A/D Result R	egister Low	•		•		•		xxxx xxxx	uuuu uuuu
09Ch	ADRESH	A/D Result R	egister High							xxxx xxxx	uuuu uuuu
09Dh	ADCON0	_			CHS<4:0>			GO/DONE	ADON	-000 0000	-000 0000
09Eh	ADCON1	ADFM		ADCS<2:0>		_	_	ADPR	EF<1:0>	000000	000000
09Fh	_	Unimplement	ted					•		_	_
						:I					

Legend: x = unknown, u = unchanged, q = value depends on condition, -= unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

2: PIC16(L)F1823 only.

3: Unimplemented. Read as '1'.

4: PIC12(L)F1822 only.

4.2 Code Protection

Code protection allows the device to be protected from unauthorized access. Program memory protection and data EEPROM protection are controlled independently. Internal access to the program memory and data EEPROM are unaffected by any code protection setting.

4.2.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the \overline{CP} bit in Configuration Word 1. When $\overline{CP}=0$, external reads and writes of program memory are inhibited and a read will return all 'o's. The CPU can continue to read program memory, regardless of the protection bit settings. Writing the program memory is dependent upon the write protection setting. See Section 4.3 "Write Protection" for more information.

4.2.2 DATA EEPROM PROTECTION

The entire data EEPROM is protected from external reads and writes by the \overline{CPD} bit. When \overline{CPD} = 0, external reads and writes of data EEPROM are inhibited. The CPU can continue to read and write data EEPROM regardless of the protection bit settings.

4.3 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as bootloader software, can be protected while allowing other regions of the program memory to be modified.

The WRT<1:0> bits in Configuration Word 2 define the size of the program memory block that is protected.

4.4 User ID

Four memory locations (8000h-8003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See Section 11.5 "User ID, Device ID and Configuration Word Access" for more information on accessing these memory locations. For more information on checksum calculation, see the "PIC16F/LF1826/27/PIC12F/LF1822 Memory Programming Specification" (DS41390).

4.5 Device ID and Revision ID

The memory location 8006h is where the Device ID and Revision ID are stored. The upper nine bits hold the Device ID. The lower five bits hold the Revision ID. See Section 11.5 "User ID, Device ID and Configuration Word Access" for more information on accessing these memory locations.

Development tools, such as device programmers and debuggers, may be used to read the Device ID and Revision ID.

REGISTER 4-3: DEVICEID: DEVICE ID REGISTER⁽¹⁾

R	R	R	R	R	R
DEV8	DEV7	DEV6	DEV5	DEV4	DEV3
bit 13					bit 8

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:			
R = Readable bit	'0' = Bit is cleared	'1' = Bit is set	

bit 13-5 **DEV<8:0>:** Device ID bits

100111000 = PIC12F1822 100111001 = PIC16F1823 101000000 = PIC12LF1822 101000001 = PIC16LF1823

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to identify the revision.

Note 1: This location cannot be written.

TABLE 7-5: SUMMARY OF REGISTERS ASSOCIATED WITH RESETS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BORCON	SBOREN	_	_		_	_	_	BORRDY	74
PCON	STKOVF	STKUNF	_	_	RMCLR	RI	POR	BOR	78
STATUS	_	_	_	TO	PD	Z	DC	С	20
WDTCON	_	_	WDTPS4	WDTPS3	WDTPS2	WDTPS1	WDTPS0	SWDTEN	97

Legend: — = unimplemented bit, reads as '0'. Shaded cells are not used by Resets.

8.5.1 INTCON REGISTER

The INTCON register is a readable and writable register, which contains the various enable and flag bits for TMR0 register overflow, interrupt-on-change and external INT pin interrupts.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 8-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0/0	R-0/0						
GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF ⁽¹⁾
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7	GIE: Global Interrupt Enable bit
	1 = Enables all active interrupts0 = Disables all interrupts
bit 6	PEIE: Peripheral Interrupt Enable bit 1 = Enables all active peripheral interrupts 0 = Disables all peripheral interrupts
bit 5	TMR0IE: Timer0 Overflow Interrupt Enable bit 1 = Enables the Timer0 interrupt 0 = Disables the Timer0 interrupt
bit 4	INTE: INT External Interrupt Enable bit 1 = Enables the INT external interrupt 0 = Disables the INT external interrupt
bit 3	IOCIE: Interrupt-on-Change Enable bit 1 = Enables the interrupt-on-change 0 = Disables the interrupt-on-change
bit 2	TMR0IF: Timer0 Overflow Interrupt Flag bit 1 = TMR0 register has overflowed 0 = TMR0 register did not overflow
bit 1	INTF: INT External Interrupt Flag bit 1 = The INT external interrupt occurred 0 = The INT external interrupt did not occur
bit 0	IOCIF: Interrupt-on-Change Interrupt Flag bit ⁽¹⁾ 1 = When at least one of the interrupt-on-change pins changed state 0 = None of the interrupt-on-change pins have changed state

Note 1: The IOCIF Flag bit is read-only and cleared when all the Interrupt-on-Change flags in the IOCAF register have been cleared by software.

15.0 TEMPERATURE INDICATOR MODULE

This family of devices is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The circuit's range of operating temperature falls between of -40°C and +85°C. The output is a voltage that is proportional to the device temperature. The output of the temperature indicator is internally connected to the device ADC.

The circuit may be used as a temperature threshold detector or a more accurate temperature indicator, depending on the level of calibration performed. A one-point calibration allows the circuit to indicate a temperature closely surrounding that point. A two-point calibration allows the circuit to sense the entire range of temperature more accurately. Reference Application Note AN1333, "Use and Calibration of the Internal Temperature Indicator" (DS01333) for more details regarding the calibration process.

15.1 Circuit Operation

Figure 15-1 shows a simplified block diagram of the temperature circuit. The proportional voltage output is achieved by measuring the forward voltage drop across multiple silicon junctions.

Equation 15-1 describes the output characteristics of the temperature indicator.

EQUATION 15-1: VOUT RANGES

High Range: Vout = VDD - 4VT

Low Range: Vout = VDD - 2VT

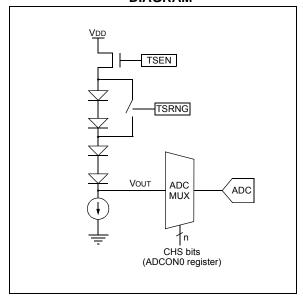
The temperature sense circuit is integrated with the Fixed Voltage Reference (FVR) module. See Section 14.0 "Fixed Voltage Reference (FVR)" for more information.

The circuit is enabled by setting the TSEN bit of the FVRCON register. When disabled, the circuit draws no current

The circuit operates in either high or low range. The high range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range, but may be less consistent from part to part. This range requires a higher bias voltage to operate and thus, a higher VDD is needed.

The low range is selected by clearing the TSRNG bit of the FVRCON register. The low range generates a lower voltage drop and thus, a lower bias voltage is needed to operate the circuit. The low range is provided for low voltage operation.

FIGURE 15-1: TEMPERATURE CIRCUIT DIAGRAM



15.2 Minimum Operating VDD vs. Minimum Sensing Temperature

When the temperature circuit is operated in low range, the device may be operated at any operating voltage that is within specifications.

When the temperature circuit is operated in high range, the device operating voltage, VDD, must be high enough to ensure that the temperature circuit is correctly biased.

Table 15-1 shows the recommended minimum VDD vs. range setting.

TABLE 15-1: RECOMMENDED VDD VS. RANGE

Min. VDD, TSRNG = 1	Min. VDD, TSRNG = 0
3.6V	1.8V

15.3 Temperature Output

The output of the circuit is measured using the internal analog to digital converter. A channel is reserved for the temperature circuit output. Refer to Section 16.0 "Analog-to-Digital Converter (ADC) Module" for detailed information.

15.3.1 ADC ACQUISITION TIME

To ensure accurate temperature measurements, the user must wait at least 200 usec after the ADC input multiplexer is connected to the temperature indicator output before the conversion is performed. In addition, the user must wait 200 usec between sequential conversions of the temperature indicator output.

20.0 TIMERO MODULE

The Timer0 module is an 8-bit timer/counter with the following features:

- · 8-bit timer/counter register (TMR0)
- 8-bit prescaler (independent of Watchdog Timer)
- · Programmable internal or external clock source
- · Programmable external clock edge selection
- · Interrupt on overflow
- TMR0 can be used to gate Timer1

Figure 20-1 is a block diagram of the Timer0 module.

20.1 Timer0 Operation

The Timer0 module can be used as either an 8-bit timer or an 8-bit counter.

20.1.1 8-BIT TIMER MODE

The Timer0 module will increment every instruction cycle, if used without a prescaler. 8-bit Timer mode is selected by clearing the TMR0CS bit of the OPTION register.

When TMR0 is written, the increment is inhibited for two instruction cycles immediately following the write.

Note:

The value written to the TMR0 register can be adjusted, in order to account for the two instruction cycle delay when TMR0 is written.

20.1.2 8-BIT COUNTER MODE

In 8-Bit Counter mode, the Timer0 module will increment on every rising or falling edge of the T0CKI pin or the Capacitive Sensing Oscillator (CPSCLK) signal.

8-Bit Counter mode using the T0CKI pin is selected by setting the TMR0CS bit in the OPTION register to '1' and resetting the T0XCS bit in the CPSCON0 register to '0'.

8-Bit Counter mode using the Capacitive Sensing Oscillator (CPSCLK) signal is selected by setting the TMR0CS bit in the OPTION register to '1' and setting the T0XCS bit in the CPSCON0 register to '1'.

The rising or falling transition of the incrementing edge for either input source is determined by the TMR0SE bit in the OPTION register.

FIGURE 20-1: BLOCK DIAGRAM OF THE TIMER0

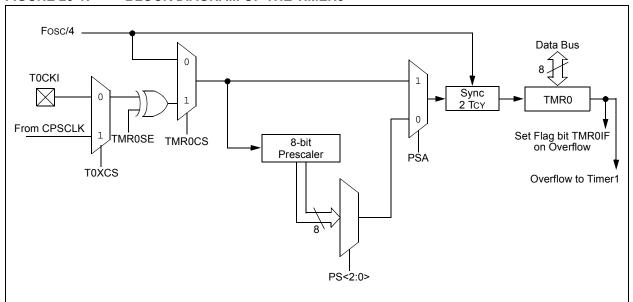


TABLE 21-5: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER1

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	_	_	_	ANSA4	_	ANSA2	ANSA1	ANSA0	118
CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	213
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	86
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	87
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	89
TMR1H	Holding Re	gister for the	Most Signi	ficant Byte	of the 16-bit	TMR1 Regi	ster		169*
TMR1L	Holding Re	gister for the	Least Sign	ificant Byte	of the 16-bit	TMR1 Reg	ister		169*
TRISA	_	_	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	117
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	1	TMR10N	173
T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ DONE	T1GVAL	T1GSS1	T1GSS0	174

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

Note 1: PIC16(L)F1823 only.

^{*} Page provides register information.

24.4.2.1 Direction Change in Full-Bridge Mode

In the Full-Bridge mode, the P1M1 bit in the CCP1CON register allows users to control the forward/reverse direction. When the application firmware changes this direction control bit, the module will change to the new direction on the next PWM cycle.

A direction change is initiated in software by changing the P1M1 bit of the CCP1CON register. The following sequence occurs four Timer cycles prior to the end of the current PWM period:

- The modulated outputs (P1B and P1D) are placed in their inactive state.
- The associated unmodulated outputs (P1A and P1C) are switched to drive in the opposite direction
- PWM modulation resumes at the beginning of the next period.

See Figure 24-12 for an illustration of this sequence.

The Full-Bridge mode does not provide dead-band delay. As one output is modulated at a time, dead-band delay is generally not required. There is a situation where dead-band delay is required. This situation occurs when both of the following conditions are true:

- The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
- The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

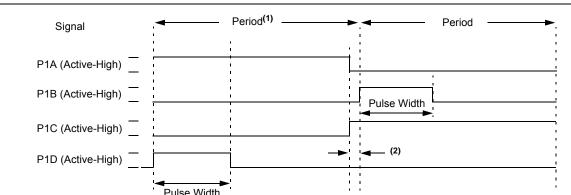
Figure 24-13 shows an example of the PWM direction changing from forward to reverse, at a near 100% duty cycle. In this example, at time t1, the output P1A and P1D become inactive, while output P1C becomes active. Since the turn off time of the power devices is longer than the turn on time, a shoot-through current will flow through power devices QC and QD (see Figure 24-10) for the duration of 't'. The same phenomenon will occur to power devices QA and QB for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, two possible solutions for eliminating the shoot-through current are:

- Reduce PWM duty cycle for one PWM period before changing directions.
- 2. Use switch drivers that can drive the switches off faster than they can drive them on.

Other options to prevent shoot-through current may exist.

FIGURE 24-12: EXAMPLE OF PWM DIRECTION CHANGE



- Note 1: The direction bit P1M1 of the CCP1CON register is written any time during the PWM cycle.
 - 2: When changing directions, the P1A and P1C signals switch before the end of the current PWM cycle. The modulated P1B and P1D signals are inactive at this time. The length of this time is four Timer counts.

24.4.3 ENHANCED PWM AUTO-SHUTDOWN MODE

The PWM mode supports an Auto-Shutdown mode that will disable the PWM outputs when an external shutdown event occurs. Auto-Shutdown mode places the PWM output pins into a predetermined state. This mode is used to help prevent the PWM from damaging the application.

The auto-shutdown sources are selected using the CCP1AS<2:0> bits of the CCP1AS register. A shutdown event may be generated by:

- A logic '0' on the FLT0 pin
- · A logic '1' on a Comparator (C1) output

A shutdown condition is indicated by the CCP1ASE (Auto-Shutdown Event Status) bit of the CCP1AS register. If the bit is a '0', the PWM pins are operating normally. If the bit is a '1', the PWM outputs are in the shutdown state.

When a shutdown event occurs, two things happen:

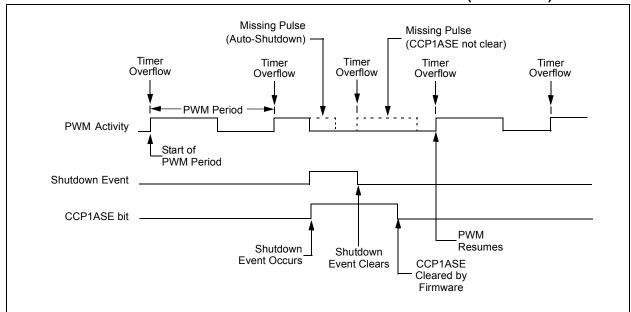
The CCP1ASE bit is set to '1'. The CCP1ASE will remain set until cleared in firmware or an auto-restart occurs (see **Section 24.4.4 "Auto-Restart Mode"**).

The enabled PWM pins are asynchronously placed in their shutdown states. The PWM output pins are grouped into pairs [P1A/P1C] and [P1B/P1D]. The state of each pin pair is determined by the PSS1AC and PSS1BD bits of the CCP1AS register. Each pin pair may be placed into one of three states:

- Drive logic '1'
- · Drive logic '0'
- Tri-state (high-impedance)

- Note 1: The auto-shutdown condition is a levelbased signal, not an edge-based signal. As long as the level is present, the autoshutdown will persist.
 - 2: Writing to the CCP1ASE bit is disabled while an auto-shutdown condition persists.
 - **3:** Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart) the PWM signal will always restart at the beginning of the next PWM period.
 - 4: Prior to an auto-shutdown event caused by a comparator output or FLT0 pin event, a software shutdown can be triggered in firmware by setting the CCP1ASE bit of the CCP1AS register to '1'. The autorestart feature tracks the active status of a shutdown caused by a comparator output or FLT0 pin event only. If it is enabled at this time, it will immediately clear this bit and restart the ECCP module at the beginning of the next PWM period.

FIGURE 24-14: PWM AUTO-SHUTDOWN WITH FIRMWARE RESTART (P1RSEN = 0)



25.4.5 START CONDITION

The I²C specification defines a Start condition as a transition of SDA from a high to a low state while SCL line is high. A Start condition is always generated by the master and signifies the transition of the bus from an Idle to an Active state. Figure 25-12 shows wave forms for Start and Stop conditions.

A bus collision can occur on a Start condition if the module samples the SDA line low before asserting it low. This does not conform to the I²C Specification that states no bus collision can occur on a Start.

25.4.6 STOP CONDITION

A Stop condition is a transition of the SDA line from low-to-high state while the SCL line is high.

Note: At least one SCL low time must appear before a Stop is valid, therefore, if the SDA line goes low then high again while the SCL line stays high, only the Start condition is detected.

25.4.7 RESTART CONDITION

A Restart is valid any time that a Stop would be valid. A master can issue a Restart if it wishes to hold the bus after terminating the current transfer. A Restart has the same effect on the slave that a Start would, resetting all slave logic and preparing it to clock in an address. The master may want to address the same or another slave. Figure 25-13 shows wave forms for a Restart condition.

In 10-bit Addressing Slave mode a Restart is required for the master to clock data out of the addressed slave. Once a slave has been fully addressed, matching both high and low address bytes, the master can issue a Restart and the high address byte with the R/\overline{W} bit set. The slave logic will then hold the clock and prepare to clock out data.

After a full match with R/\overline{W} clear in 10-bit mode, a prior match flag is set and maintained. Until a Stop condition, a high address with R/\overline{W} clear, or high address match fails.

25.4.8 START/STOP CONDITION INTERRUPT MASKING

The SCIE and PCIE bits of the SSP1CON3 register can enable the generation of an interrupt in Slave modes that do not typically support this function. Slave modes where interrupt on Start and Stop detect are already enabled, these bits will have no effect.

FIGURE 25-12: I²C START AND STOP CONDITIONS

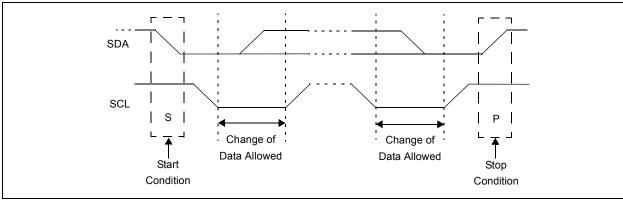
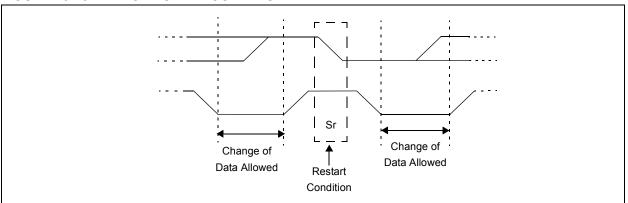


FIGURE 25-13: I²C RESTART CONDITION



25.5.6 CLOCK STRETCHING

Clock stretching occurs when a device on the bus holds the SCL line low effectively pausing communication. The slave may stretch the clock to allow more time to handle data or prepare a response for the master device. A master device is not concerned with stretching as anytime it is active on the bus and not transferring data it is stretching. Any stretching done by a slave is invisible to the master software and handled by the hardware that generates SCL.

The CKP bit of the SSP1CON1 register is used to control stretching in software. Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. Setting CKP will release SCL and allow more communication.

25.5.6.1 Normal Clock Stretching

Following an ACK if the R/W bit of SSP1STAT is set, a read request, the slave hardware will clear CKP. This allows the slave time to update SSP1BUF with data to transfer to the master. If the SEN bit of SSP1CON2 is set, the slave hardware will always stretch the clock after the ACK sequence. Once the slave is ready; CKP is set by software and communication resumes.

- Note 1: The BF bit has no effect on if the clock will be stretched or not. This is different than previous versions of the module that would not stretch the clock, clear CKP, if SSP1BUF was read before the ninth falling edge of SCL.
 - 2: Previous versions of the module did not stretch the clock for a transmission if SSP1BUF was loaded before the ninth falling edge of SCL. It is now always cleared for read requests.

25.5.6.2 10-bit Addressing Mode

In 10-bit Addressing mode, when the UA bit is set, the clock is always stretched. This is the only time the SCL is stretched without CKP being cleared. SCL is released immediately after a write to SSP1ADD.

Note: Previous versions of the module did not stretch the clock if the second address byte did not match.

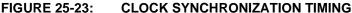
25.5.6.3 Byte NACKing

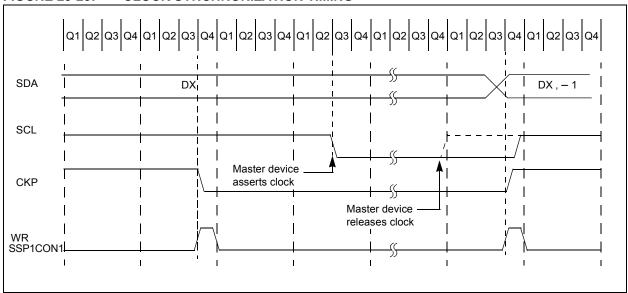
When AHEN bit of SSP1CON3 is set; CKP is cleared by hardware after the eighth falling edge of SCL for a received matching address byte. When DHEN bit of SSP1CON3 is set; CKP is cleared after the eighth falling edge of SCL for received data.

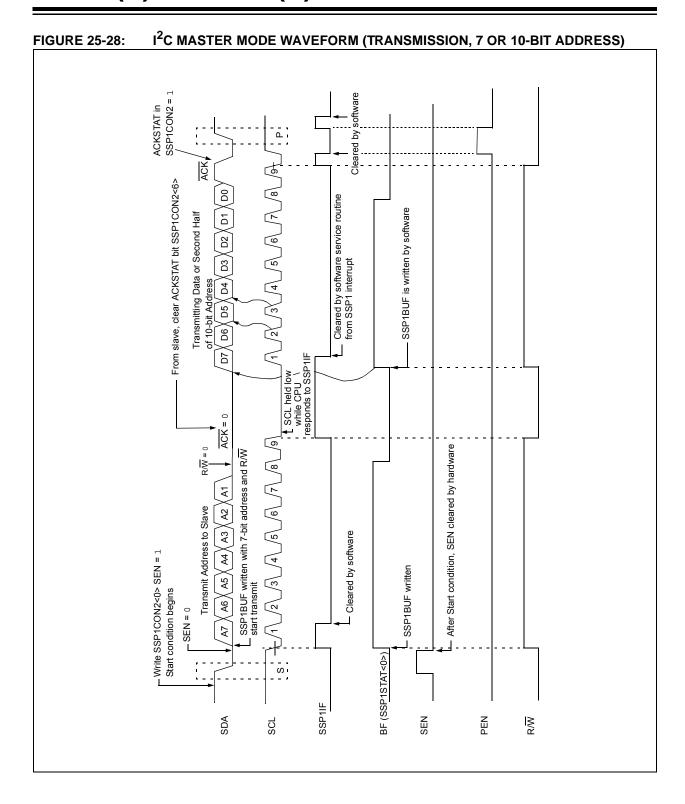
Stretching after the eighth falling edge of SCL allows the slave to look at the received address or data and decide if it wants to ACK the received data.

25.5.7 CLOCK SYNCHRONIZATION AND THE CKP BIT

Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. However, clearing the CKP bit will not assert the SCL output low until the SCL output is already sampled low. Therefore, the CKP bit will not assert the SCL line until an external I²C master device has already asserted the SCL line. The SCL output will remain low until the CKP bit is set and all other devices on the I²C bus have released SCL. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCL (see Figure 25-23).







25.6.7 I²C MASTER MODE RECEPTION

Master mode reception (Figure 25-29) is enabled by programming the Receive Enable bit, RCEN bit of the SSP1CON2 register.

Note: The MSSP1 module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover, the state of the SCL pin changes (high-to-low/low-to-high) and data is shifted into the SSP1SR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSP1SR are loaded into the SSP1BUF, the BF flag bit is set, the SSP1IF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCL low. The MSSP1 is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable, ACKEN bit of the SSP1CON2 register.

25.6.7.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSP1BUF from SSP1SR. It is cleared when the SSP1BUF register is read.

25.6.7.2 SSP1OV Status Flag

In receive operation, the SSP1OV bit is set when eight bits are received into the SSP1SR and the BF flag bit is already set from a previous reception.

25.6.7.3 WCOL Status Flag

If the user writes the SSP1BUF when a receive is already in progress (i.e., SSP1SR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write does not occur).

25.6.7.4 Typical Receive Sequence:

- The user generates a Start condition by setting the SEN bit of the SSP1CON2 register.
- SSP1IF is set by hardware on completion of the Start.
- 3. SSP1IF is cleared by software.
- User writes SSP1BUF with the slave address to transmit and the R/W bit set.
- 5. Address is shifted out the SDA pin until all eight bits are transmitted. Transmission begins as soon as SSP1BUF is written to.
- 6. The MSSP1 module shifts in the ACK bit from the slave device and writes its value into the ACKSTAT bit of the SSP1CON2 register.
- The MSSP1 module generates an interrupt at the end of the ninth clock cycle by setting the SSP1IF bit.

- 8. User sets the RCEN bit of the SSP1CON2 register and the Master clocks in a byte from the slave.
- After the eighth falling edge of SCL, SSP1IF and BF are set.
- Master clears SSP1IF and reads the received byte from SSP1UF, clears BF.
- Master sets ACK value sent to slave in ACKDT bit of the SSP1CON2 register and initiates the ACK by setting the ACKEN bit.
- Masters ACK is clocked out to the Slave and SSP1IF is set.
- 13. User clears SSP1IF.
- Steps 8-13 are repeated for each received byte from the slave.
- 15. Master sends a not ACK or Stop to end communication.

25.6.10 SLEEP OPERATION

While in Sleep mode, the I²C slave module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP1 interrupt is enabled).

25.6.11 EFFECTS OF A RESET

A Reset disables the MSSP1 module and terminates the current transfer.

25.6.12 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP1 module is disabled. Control of the I²C bus may be taken when the P bit of the SSP1STAT register is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed by hardware with the result placed in the BCL1IF bit.

The states where arbitration can be lost are:

- · Address Transfer
- · Data Transfer
- · A Start Condition
- · A Repeated Start Condition
- An Acknowledge Condition

25.6.13 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin is '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCL1IF, and reset the I²C port to its Idle state (Figure 25-32).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSP1BUF can be written to. When the user services the bus collision Interrupt Service Routine and if the $\rm I^2C$ bus is free, the user can resume communication by asserting a Start condition.

If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSP1CON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSP1IF bit will be set.

A write to the SSP1BUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSP1STAT register, or the bus is Idle and the S and P bits are cleared.



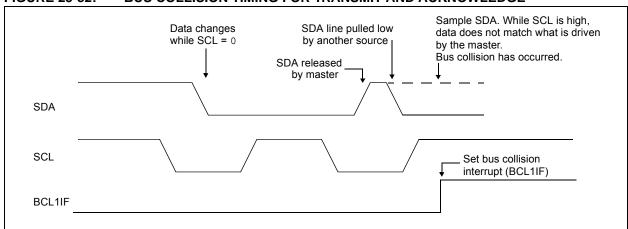


TABLE 26-3: BAUD RATE FORMULAS

Configuration Bits			DDC/FUCADT Mada	Baud Rate Formula		
SYNC	BRG16	BRGH	BRG/EUSART Mode	Baud Rate Formula		
0	0	0	8-bit/Asynchronous	Fosc/[64 (n+1)]		
0	0	1	8-bit/Asynchronous	F000//40 (n.14)]		
0	1	0	16-bit/Asynchronous	Fosc/[16 (n+1)]		
0	1	1	16-bit/Asynchronous			
1	0	х	8-bit/Synchronous	Fosc/[4 (n+1)]		
1	1	х	16-bit/Synchronous			

Legend: x = Don't care, n = value of SPBRGH, SPBRGL register pair.

TABLE 26-4: SUMMARY OF REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	279
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	278
SPBRGL	BRG<7:0>								280*
SPBRGH	BRG<15:8>							280*	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	277

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for the Baud Rate Generator.

^{*} Page provides register information.

SWAPF	Swap Nibbles in f				
Syntax:	[label] SWAPF f,d				
Operands:	$0 \le f \le 127$ $d \in [0,1]$				
Operation:	$(f<3:0>) \rightarrow (destination<7:4>),$ $(f<7:4>) \rightarrow (destination<3:0>)$				
Status Affected:	None				
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in register 'f'.				

TRIS	Load TRIS Register with W
Syntax:	[label] TRIS f
Operands:	$5 \leq f \leq 7$
Operation:	$(W) \rightarrow TRIS$ register 'f'
Status Affected:	None
Description:	Move data from W register to TRIS register. When 'f' = 5, TRISA is loaded. When 'f' = 6, TRISB is loaded. When 'f' = 7, TRISC is loaded.

XORLW	Exclusive OR literal with W					
Syntax:	[label] XORLW k					
Operands:	$0 \leq k \leq 255$					
Operation:	(W) .XOR. $k \rightarrow (W)$					
Status Affected:	Z					
Description:	The contents of the W register are XOR'ed with the 8-bit literal 'k'. The result is placed in the W register.					

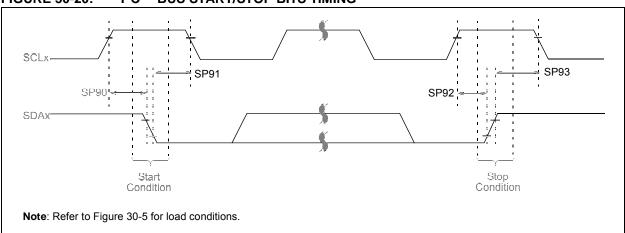
XORWF	Exclusive OR W with f					
Syntax:	[label] XORWF f,d					
Operands:	$0 \le f \le 127$ $d \in [0,1]$					
Operation:	(W) .XOR. (f) \rightarrow (destination)					
Status Affected:	Z					
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.					

TABLE 30-14: SPI MODE REQUIREMENTS

Param No.	Symbol	Characteristic	Min.	Тур†	Max.	Units	Conditions	
SP70*	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ input	2.25 TcY	_	_	ns		
SP71*	TscH	SCKx input high time (Slave mod	de)	Tcy + 20	_	_	ns	
SP72*	TscL	SCKx input low time (Slave mod	e)	Tcy + 20		_	ns	
SP73*	TDIV2scH, TDIV2scL	Setup time of SDIx data input to	100	_	_	ns		
SP74*	TscH2DIL, TscL2DIL	Hold time of SDIx data input to S	100	_	_	ns		
SP75* TDOR		SDO data output rise time	3.0-5.5V	_	10	25	ns	
			1.8-5.5V	_	25	50	ns	
SP76*	TDOF	SDOx data output fall time		_	10	25	ns	
SP77*	TssH2DoZ	SSx [↑] to SDOx output high-impe	10	_	50	ns		
SP78* TscR	SCKx output rise time	3.0-5.5V	_	10	25	ns		
		(Master mode)	1.8-5.5V	_	25	50	ns	
SP79*	TscF	SCKx output fall time (Master mo	ode)	_	10	25	ns	
SP80*	TscH2DoV,	cH2DOV, SDOx data output valid after	3.0-5.5V	_	_	50	ns	
	TscL2DoV	SCKx edge	1.8-5.5V	_	_	145	ns	
SP81*	TDOV2scH, TDOV2scL	SDOx data output setup to SCK	Tcy	_	_	ns		
SP82*	TssL2DoV	SDOx data output valid after SS	_	_	50	ns		
SP83*	TscH2ssH, TscL2ssH	SSx ↑ after SCKx edge	1.5Tcy + 40	_	_	ns		

^{*} These parameters are characterized but not tested.

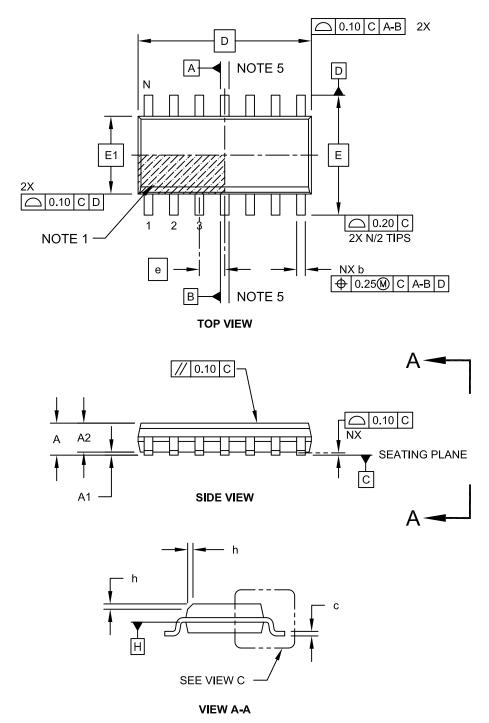
FIGURE 30-20: I²C™ BUS START/STOP BITS TIMING



[†] Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

14-Lead Plastic Small Outline (SL) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-065C Sheet 1 of 2